IPC ASSOCIATION ELECTRONIC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
Supplier	r Information														
Company name*			Company unique ID			1	Unique ID Authority					Response Date*			
nsemi											2025-06-05				
Contact N	ame	Title - Contact			1	Phone - Contact*				Email - Contact*					
Product-l	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
uthorize	d Representative*	Title - Representative			1	Phone - Representative*				Email - Representative*					
Product-l	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date Version Manufacturing		Manufacturing Site	7	Veight*	UOM	Unit Type		
		HMHA2801 4SO TR		4SO TR	O TR		2025-06-05			LITEONFG		4.749	mg	Each	
<b>Ianufa</b>	cturing Process Informa	ation						·							
	Terminal Plating / Grid Array Material Terminal Base Alloy			Alloy J-	STD-020 MS	0-020 MSL Rating Peak Process Body Temperature Max Time at Pe					Temperat	ire Nun	ber of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy 1					245		C	30	secon	is 3					
Comments															
evel 1 - m	aximum time at peak temperat	ture during sol	dering is 10-3	0 seconds											
or more	information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.267	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.0864	mg
			Supplier	Silicon (Si)	7440-21-3		0.1754	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0052	mg
Die Attach	0.021	mg	Supplier	Silver (Ag)	7440-22-4		0.0172	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0038	mg
Lead Frame	13.225	mg	Supplier	Silver (Ag)	7440-22-4		0.6784	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0238	mg
			Supplier	Iron (Fe)	7439-89-6		0.3253	mg
			Supplier	Copper (Cu)	7440-50-8		12.1789	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0185	mg
Mold Compound-White	31.422	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		7.8555	mg
			В	Brominated Bisphenol A Diglycidyl Ether	40039-93-8		0.9427	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		4.242	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.9427	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		15.711	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.7282	mg
Plating	0.961	mg	Supplier	Tin (Sn)	7440-31-5		0.961	mg
Protective Coating	8.8		Supplier	Poly(dimethylsiloxane), hydroxy terminated	70131-67-8		4.4	mg
			Supplier	Ethylbenzene	100-41-4		0.88	mg
			Supplier	Filler (SiO2)	68909-20-6		1.672	mg
			Supplier	Misc.	Proprietary Data		0.088	mg
			Supplier	Xylene	1330-20-7		1.76	mg
Wire Bond - Au	0.053	mg	Supplier	Gold (Au)	7440-57-5		0.053	mg